

<u>Docket No.: 4770-0103PUS1</u>

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Daisuke UCHIDA et al.

Application No.: 10/511,143

Confirmation No.: 1981

Examiner: C. F. F. Lam

Filed: October 14, 2004

Art Unit: 1775

For: VARNISH, FORMED MATERIAL,

ELECTRICAL INSULATION FILM, MULTILAYER STRUCTURE, FLAME

RETARDANT SLURRY AND PREPARATION

PROCESS OF FLAME RETARDANT

PARTICLES AND VARNISH

AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116

MS AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In reply to the outstanding Office Action dated April 19, 2007, the period for replying having been extended two months to September 19, 2007, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes Amended set of Claims and Remarks.